

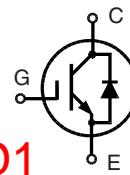
## High Voltage IGBT with optional Diode

High Speed,  
Low Saturation Voltage

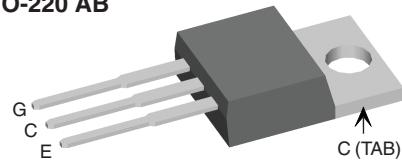
$V_{CES}$  = 600 V  
 $I_{C25}$  = 32 A  
 $V_{CE(sat)\text{ typ}}$  = 2.2 V

Replacements:  
**IXYP15N65C3D1 / IXXP12N65B4D1**

Symbol	Conditions	Maximum Ratings		
$V_{CES}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	600	V	
$V_{CGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 20 \text{ k}\Omega$	600	V	
$V_{GES}$	Continuous	$\pm 20$	V	
$V_{GEM}$	Transient	$\pm 30$	V	
$I_{C25}$	$T_c = 25^\circ\text{C}$	32	A	
$I_{C90}$	$T_c = 90^\circ\text{C}$	20	A	
$I_{CM}$	$T_c = 90^\circ\text{C}$ , $t_p = 1 \text{ ms}$	40	A	
<b>RBSOA</b>	$V_{GE} = \pm 15 \text{ V}$ , $T_j = 125^\circ\text{C}$ , $R_g = 22 \Omega$ Clamped inductive load, $L = 30 \mu\text{H}$	$I_{CM} = 60$	A	
<b>t<sub>sc</sub> (SCSOA)</b>	$V_{GE} = \pm 15 \text{ V}$ , $V_{CE} = 600 \text{ V}$ , $T_j = 125^\circ\text{C}$ $R_g = 22 \Omega$ , non repetitive	10	$\mu\text{s}$	
<b>P<sub>c</sub></b>	$T_c = 25^\circ\text{C}$	IGBT Diode	140 50	W W
<b>T<sub>j</sub></b>			-55 ... +150	$^\circ\text{C}$
<b>T<sub>stg</sub></b>			-40 ... +150	$^\circ\text{C}$
Maximum lead temperature for soldering 1.6 mm (0.062 in.) from case for 10 s			300	$^\circ\text{C}$
<b>M<sub>d</sub></b>	Mounting torque		0.4 - 0.6	Nm
<b>Weight</b>			2	g



TO-220 AB



G = Gate,  
C = Collector ,  
TAB = Collector

### Features

- NPT IGBT technology
- low switching losses
- low tail current
- no latch up
- short circuit capability
- positive temperature coefficient for easy paralleling
- MOS input, voltage controlled
- optional ultra fast diode
- International standard package

### Advantages

- Space savings
- High power density

### Typical Applications

- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

Symbol	Conditions	Characteristic Values		
		( $T_j = 25^\circ\text{C}$ , unless otherwise specified)		
$V_{(BR)CES}$	$V_{GE} = 0 \text{ V}$	600		V
$V_{GE(\text{th})}$	$I_c = 0.4 \text{ mA}$ , $V_{CE} = V_{GE}$	3		V
$I_{CES}$	$V_{CE} = V_{CES}$	$T_j = 25^\circ\text{C}$	0.7	0.1 mA
		$T_j = 125^\circ\text{C}$		mA
$I_{GES}$	$V_{CE} = 0 \text{ V}$ , $V_{GE} = \pm 20 \text{ V}$		$\pm 500$	nA
$V_{CE(\text{sat})}$	$I_c = 20 \text{ A}$ , $V_{GE} = 15 \text{ V}$	2.2	2.8	V

IXYS reserves the right to change limits, test conditions and dimensions.

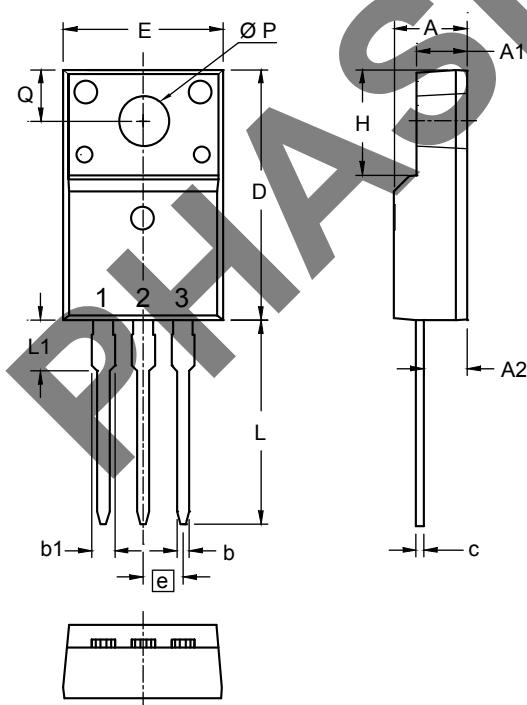
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Symbol	Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$C_{ies}$		800	pF	
$C_{oes}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1 \text{ MHz}$	85	pF	
$C_{res}$		50	pF	
$Q_g$	$I_C = 20 \text{ A}, V_{GE} = 15 \text{ V}, V_{CE} = 480 \text{ V}$	70	nC	
$t_{d(on)}$		25	ns	
$t_r$		30	ns	
$t_{d(off)}$	<b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b>	260	ns	
$t_f$	$I_C = 20 \text{ A}, V_{GE} = \pm 15 \text{ V}, V_{CE} = 300 \text{ V}, R_G = 22 \Omega$	55	ns	
$E_{on}$		0.9	mJ	
$E_{off}$		0.4	mJ	
$R_{thJC}$	Package with heatsink compound	0.5		0.9 K/W
$R_{thCH}$	Package with heatsink compound	0.25		K/W

**Reverse Diode (FRED) [D1 version only]**

Symbol	Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$V_F$	$I_F = 20 \text{ A}, V_{GE} = 0 \text{ V}$ $I_F = 20 \text{ A}, V_{GE} = 0 \text{ V}, T_J = 125^\circ\text{C}$	2.1 1.6	2.4 V	V
$I_F$	$T_c = 25^\circ\text{C}$ $T_c = 90^\circ\text{C}$		25 15	A A
$I_{RM}$	$I_F = 10 \text{ A}, -di_F/dt = 400 \text{ A}/\mu\text{s}, V_R = 300 \text{ V}$	11		A
$t_{rr}$	$V_{GE} = 0 \text{ V}, T_J = 125^\circ\text{C}$	80		ns
$t_{rr}$	$I_F = 1 \text{ A}, -di_F/dt = 100 \text{ A}/\mu\text{s}, V_R = 30 \text{ V}, V_{GE} = 0 \text{ V}$	40		ns
$R_{thJC}$			2.5	K/W

TO-220 AB Outline



Dim.	Millimeters		Inches	
	min	max	min	max
A	4.50	4.90	0.177	0.193
A1	2.34	2.74	0.092	0.108
A2	2.56	2.96	0.101	0.117
b	0.70	0.90	0.028	0.035
c	0.45	0.60	0.018	0.024
D	15.67	16.07	0.617	0.633
E	9.96	10.36	0.392	0.408
e	2.54 BSC		0.100 BSC	
H	6.48	6.88	0.255	0.271
L	12.68	13.28	0.499	0.523
L1	3.03	3.43	0.119	0.135
ØP	3.08	3.28	0.121	0.129
Q	3.20	3.40	0.126	0.134

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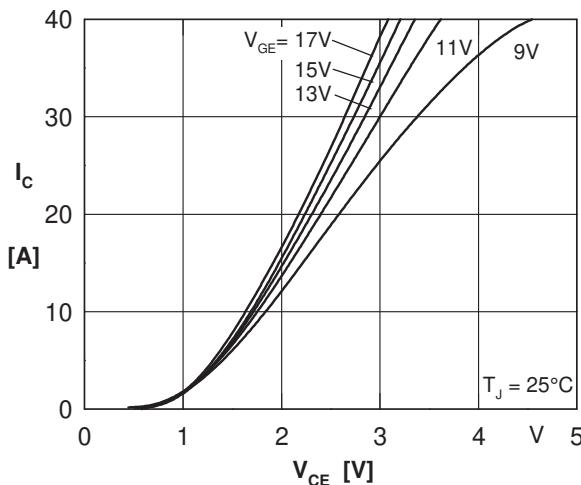


Fig. 1 Typ. output characteristics

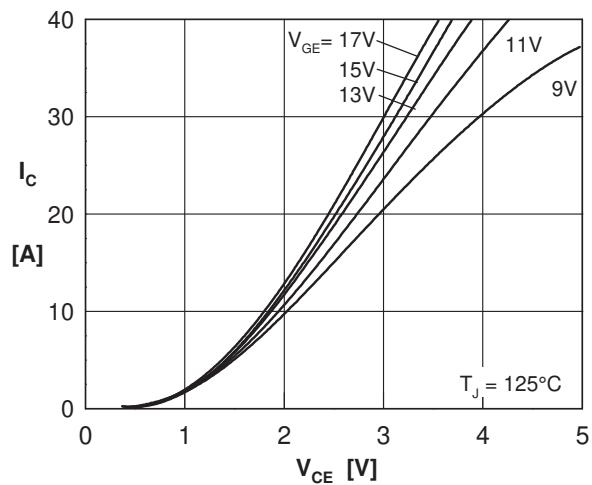


Fig. 2 Typ. output characteristics

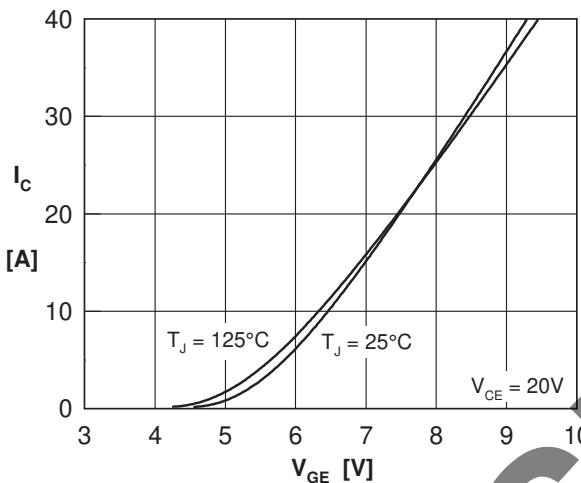


Fig. 3 Typ. transfer characteristics

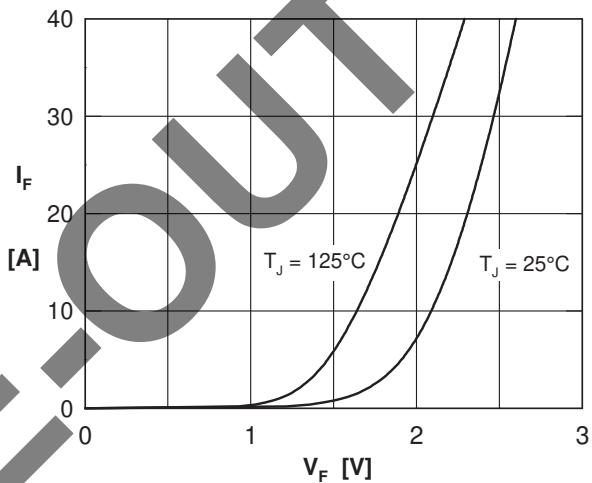


Fig. 4 Typ. forward characteristics of free wheeling diode

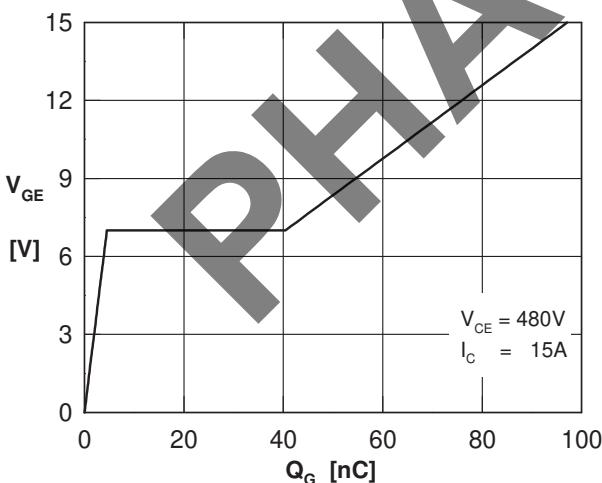


Fig. 5 Typ. turn on gate charge

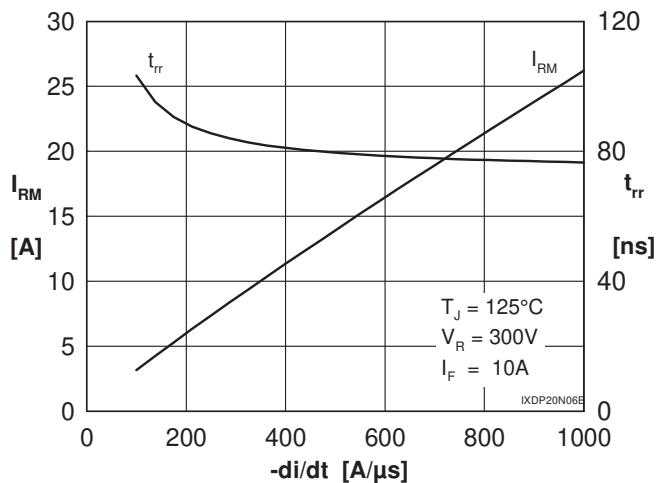


Fig. 6 Typ. turn off characteristics of free wheeling diode

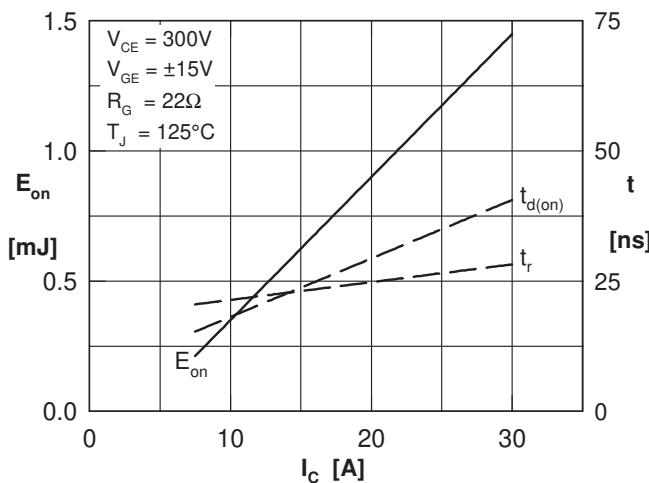


Fig. 7 Typ. turn on energy and switching times versus collector current

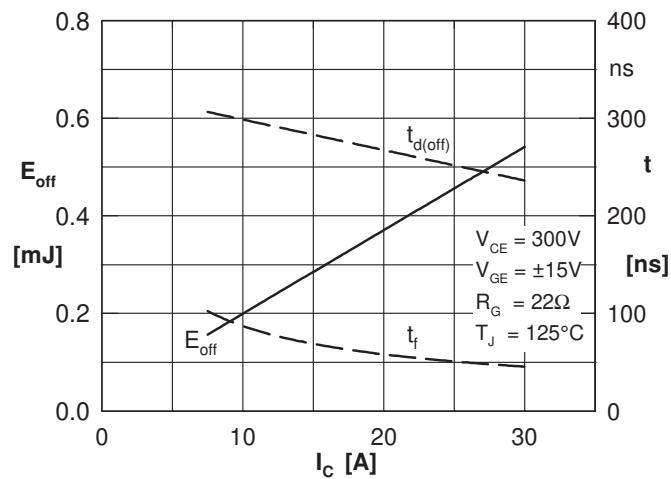


Fig. 8 Typ. turn off energy and switching times versus collector current

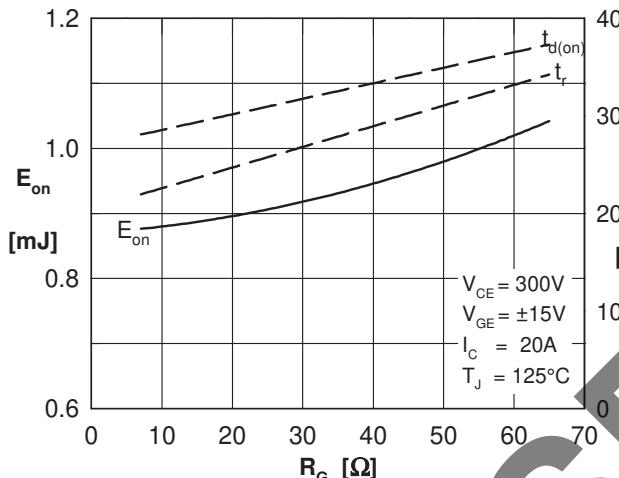


Fig. 9 Typ. turn on energy and switching times versus gate resistor

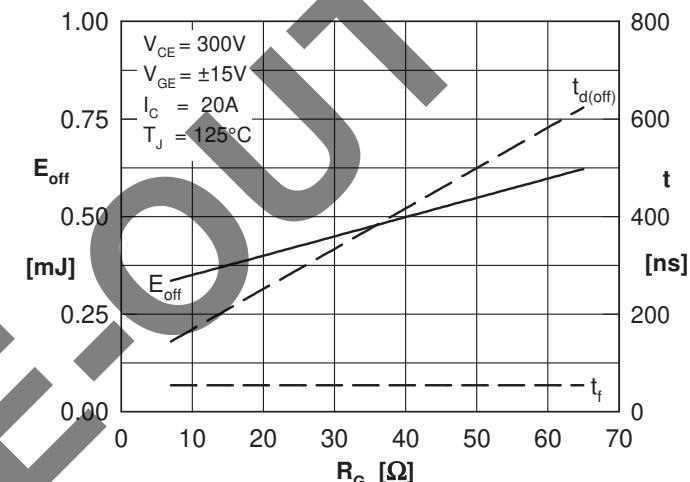


Fig. 10 Typ. turn off energy and switching times versus gate resistor

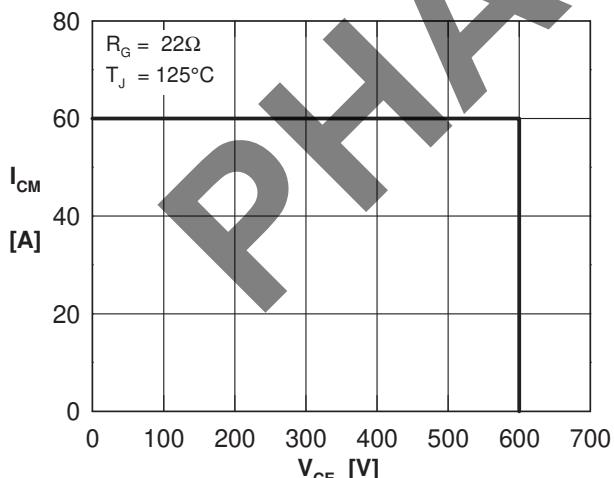


Fig. 5 Typ. turn on gate charge

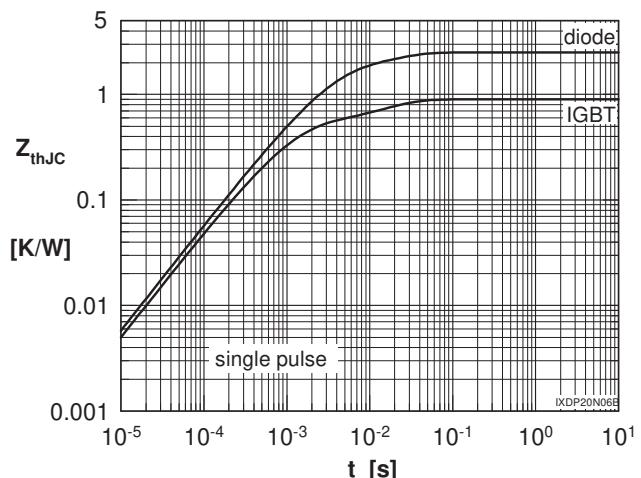


Fig. 6 Typ. turn off characteristics of free wheeling diode